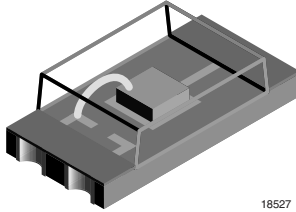


## Ambient Light Sensor



18527

### DESCRIPTION

TEMT6000X01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 1206 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 570 nm.

### FEATURES

- Package type: surface mount
- Package form: 1206
- Dimensions (L x W x H in mm): 4 x 2 x 1.05
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Angle of half sensitivity:  $\varphi = \pm 60^\circ$
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

 AUTOMOTIVE  
GRADE

**RoHS**  
COMPLIANT  
**GREEN**  
(5-2009)\*\*

### Note

\*\* Please see document "Vishay Material Category Policy":  
[www.vishay.com/doc?99902](http://www.vishay.com/doc?99902)

### APPLICATIONS

Ambient light sensor for control of display backlight dimming in LCD displays and keypad backlighting of mobile devices and in industrial on/off-lighting operation.

- Automotive sensors
- Mobile phones
- Notebook computers
- PDA's
- Cameras
- Dashboards

### PRODUCT SUMMARY

COMPONENT	$I_{PCE}$ ( $\mu A$ )	$\varphi$ (deg)	$\lambda_{0.5}$ (nm)
TEMT6000X01	50	$\pm 60$	440 to 800

### Note

- Test condition see table "Basic Characteristics"

### ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT6000X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	1206

### Note

- MOQ: minimum order quantity

### ABSOLUTE MAXIMUM RATINGS ( $T_{amb} = 25^\circ C$ , unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		$V_{CEO}$	6	V
Emitter collector voltage		$V_{ECO}$	1.5	V
Collector current		$I_C$	20	mA
Power dissipation		$P_V$	100	mW

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Junction temperature		$T_j$	100	$^{\circ}\text{C}$
Operating temperature range		$T_{amb}$	- 40 to + 100	$^{\circ}\text{C}$
Storage temperature range		$T_{stg}$	- 40 to + 100	$^{\circ}\text{C}$
Soldering temperature	Acc. reflow solder profile fig. 8	$T_{sd}$	260	$^{\circ}\text{C}$
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	$R_{thJA}$	450	K/W

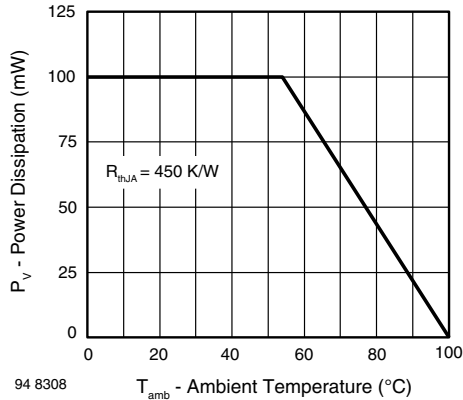


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

<b>BASIC CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)						
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Collector emitter breakdown voltage	$I_C = 0.1\text{ mA}$	$V_{CEO}$	6			V
Collector dark current	$V_{CE} = 5\text{ V}$ , $E = 0$	$I_{CEO}$		3	50	nA
Collector emitter capacitance	$V_{CE} = 0\text{ V}$ , $f = 1\text{ MHz}$ , $E = 0$	$C_{CEO}$		16		pF
Collector light current	$E_V = 20\text{ lx}$ , CIE illuminant A, $V_{CE} = 5\text{ V}$	$I_{PCE}$	3.5	10	16	$\mu\text{A}$
	$E_V = 100\text{ lx}$ , CIE illuminant A, $V_{CE} = 5\text{ V}$	$I_{PCE}$		50		$\mu\text{A}$
Temperature coefficient of $I_{PCE}$	CIE illuminant A	$TK_{I_{PCE}}$		1.18		%/K
	LED, white	$TK_{I_{PCE}}$		0.9		%/K
Angle of half sensitivity		$\varphi$		$\pm 60$		deg
Wavelength of peak sensitivity		$\lambda_p$		570		nm
Range of spectral bandwidth		$\lambda_{0.5}$		440 to 800		nm
Collector emitter saturation voltage	$E_V = 20\text{ lx}$ , CIE illuminant A, $I_{PCE} = 1.2\text{ }\mu\text{A}$	$V_{CEsat}$		0.1		V

**BASIC CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)

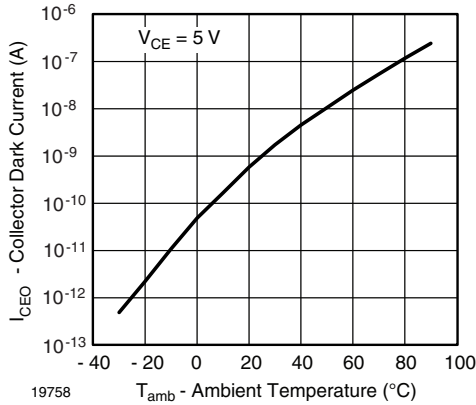


Fig. 1 - Collector Dark Current vs. Ambient Temperature

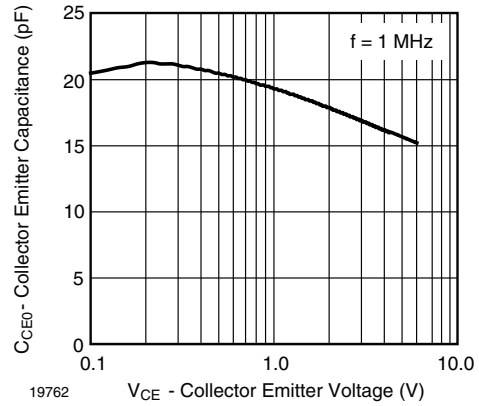


Fig. 4 - Collector Emitter Capacitance vs. Collector Emitter Voltage

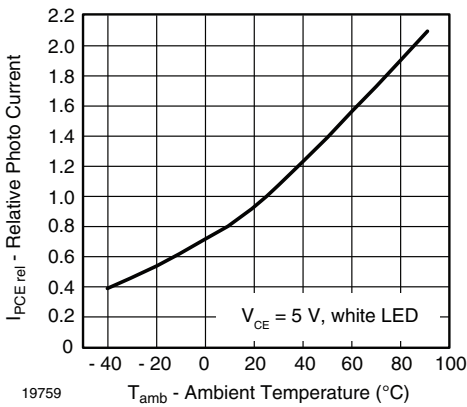


Fig. 2 - Relative Photo Current vs. Ambient Temperature

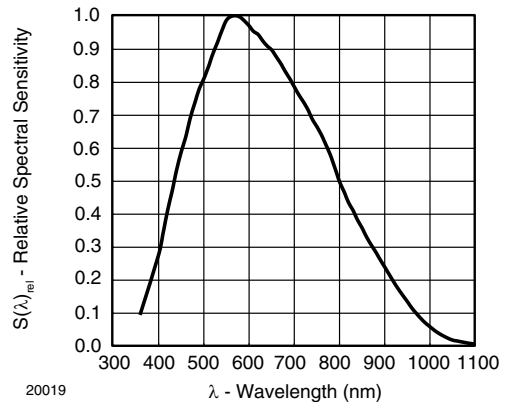


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

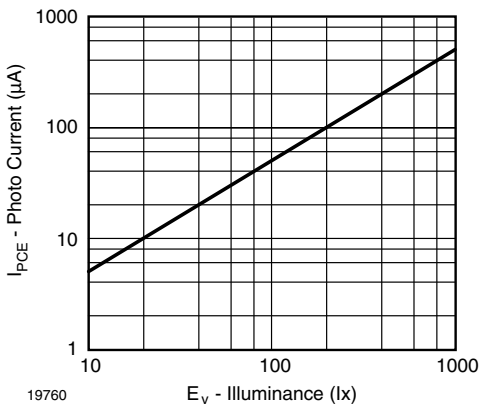


Fig. 3 - Photo Current vs. Illuminance

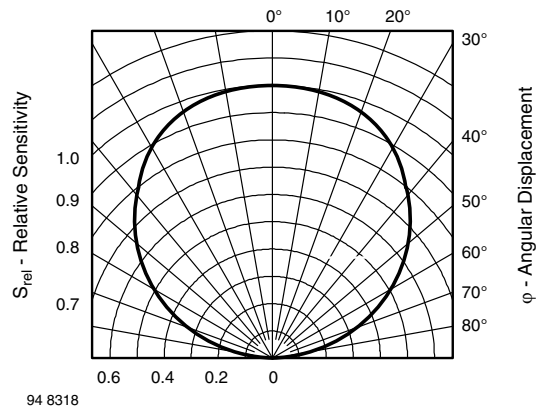


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement

**REFLOW SOLDER PROFILE**

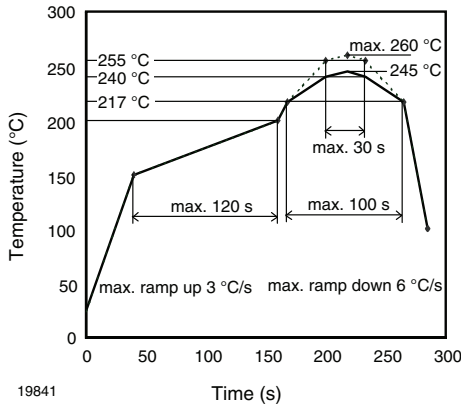


Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

**DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

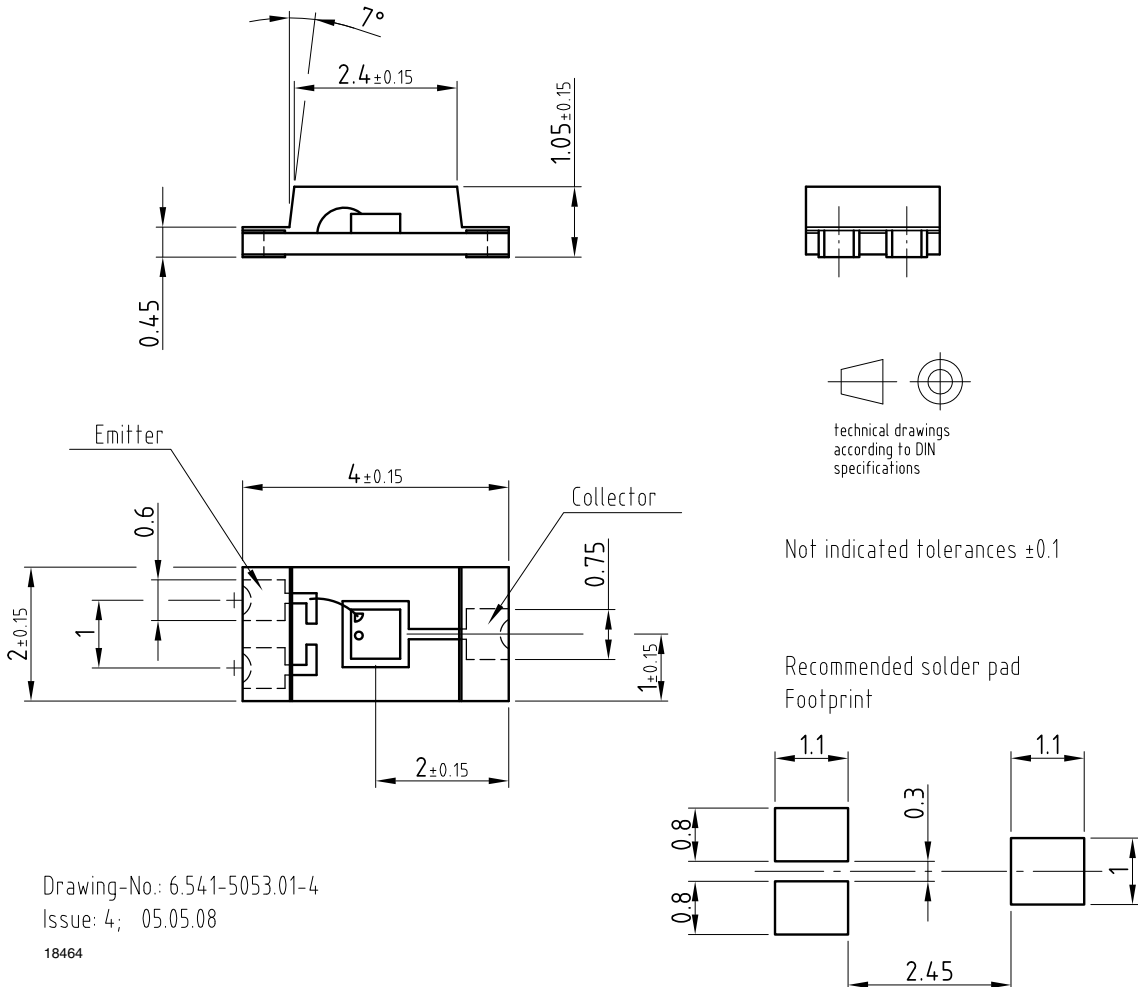
**FLOOR LIFE**

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:  
 Moisture sensitivity: level 3  
 Floor life: 168 h  
 Conditions:  $T_{amb} < 30\text{ }^{\circ}\text{C}$ , RH < 60 %

**DRYING**

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label.  
 Devices taped on reel dry using recommended conditions:  
 192 h at 40 °C (+ 5 °C), RH < 5 %  
 or  
 96 h at 60 °C (+ 5 °C), RH < 5 %.

**PACKAGE DIMENSIONS** in millimeters



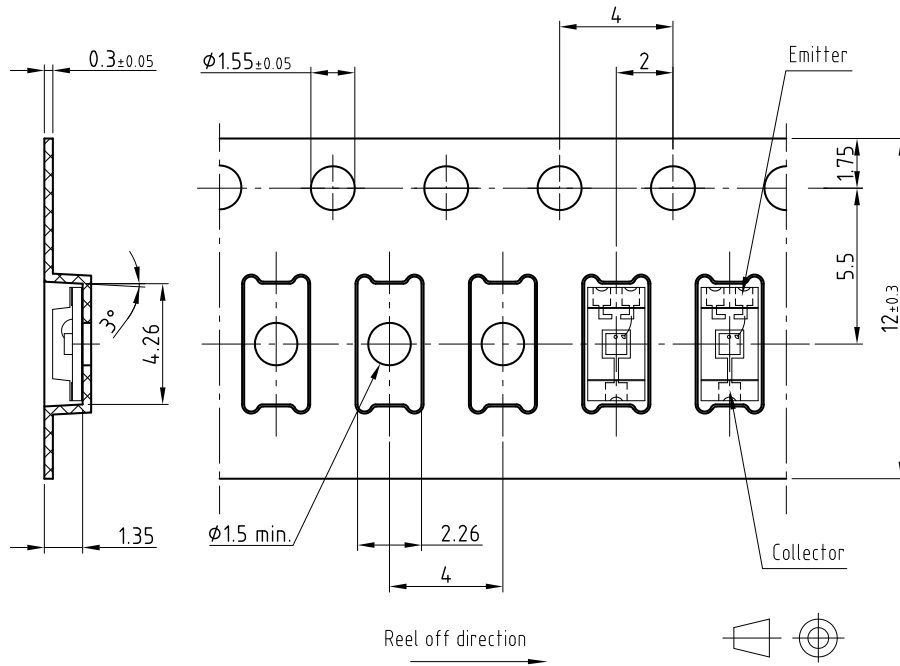
Drawing-No.: 6.541-5053.01-4  
 Issue: 4; 05.05.08  
 18464

Not indicated tolerances ±0.1

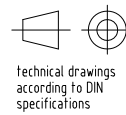
Recommended solder pad Footprint



**BLISTER TAPE DIMENSIONS** in millimeters



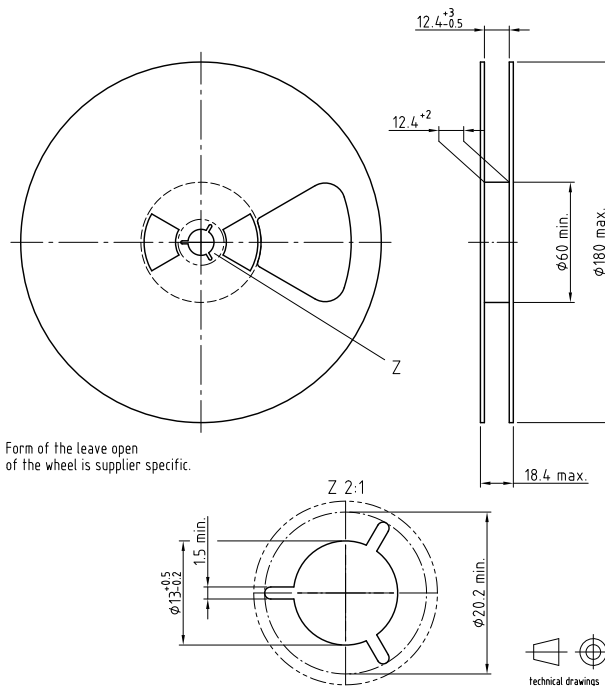
Drawing-No.: 9.700-5329.01-4  
 Issue: 1; 05.05.08  
 20876



Not indicated tolerances ±0.1

**REEL DIMENSIONS** in millimeters

Volume: 3000 pcs/reel



Form of the leave open  
 of the wheel is supplier specific.

Drawing-No.: 9.800-5097.01-4  
 Issue: 1; 05.05.08  
 20874





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